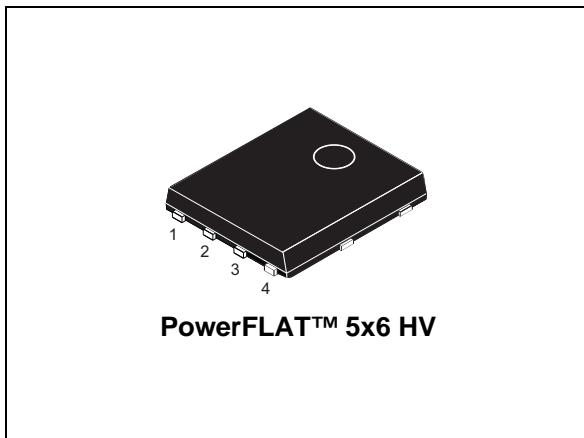
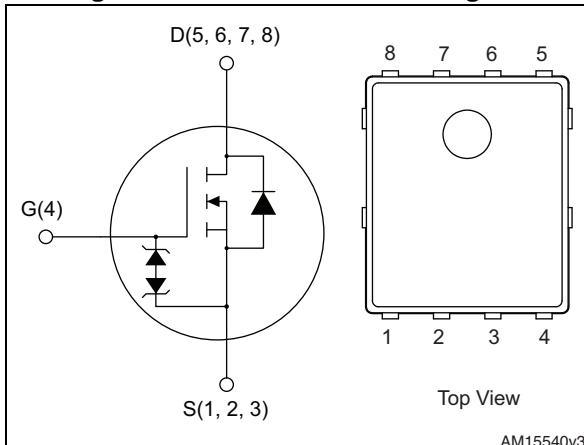


## N-channel 650 V, 0.290 $\Omega$ typ., 8 A MDmesh™ M2 Power MOSFET in a PowerFLAT™ 5x6 HV package

Datasheet - preliminary data



**Figure 1. Internal schematic diagram**



## Features

Order codes	$V_{DS} @ T_{Jmax}$	$R_{DS(on)} \text{ max}$	$I_D$
STL18N65M2	715 V	0.365 $\Omega$	8 A

- Extremely low gate charge
- Excellent output capacitance ( $C_{oss}$ ) profile
- 100% avalanche tested
- Zener-protected

## Applications

- Switching applications

## Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

**Table 1. Device summary**

Order codes	Marking	Package	Packaging
STL18N65M2	18N65M2	PowerFLAT™ 5x6 HV	Tape and reel

## Contents

1	<b>Electrical ratings</b>	3
2	<b>Electrical characteristics</b>	4
3	<b>Test circuits</b>	6
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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	$\pm 25$	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	8	A
$I_D^{(1)}$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	5	A
$I_{DM}^{(2)}$	Drain current (pulsed)	32	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	57	W
$I_{AR}$	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_j$ max)	1.8	A
$E_{AS}$	Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ )	120	mJ
$dv/dt^{(3)}$	Peak diode recovery voltage slope	15	V/ns
$dv/dt^{(4)}$	MOSFET $dv/dt$ ruggedness	50	V/ns
$T_{stg}$	Storage temperature	- 55 to 150	$^\circ\text{C}$
$T_j$	Max. operating junction temperature	150	$^\circ\text{C}$

1. The value is rated according to  $R_{thj-case}$  and limited by package
2. Pulse width limited by safe operating area
3.  $I_{SD} \leq 8\text{ A}$ ,  $di/dt \leq 400\text{ A}/\mu\text{s}$ ,  $V_{DSpeak} \leq V_{(BR)DSS}$ ,  $V_{DD} = 80\%$   $V_{(BR)DSS}$
4.  $V_{DS} \leq 520\text{ V}$

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case max	2.2	$^\circ\text{C}/\text{W}$
$R_{thj-amb}^{(1)}$	Thermal resistance junction-amb max	59	$^\circ\text{C}/\text{W}$

1. When mounted on 1inch<sup>2</sup> FR-4 board, 2 oz Cu

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 4. On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	650			V
$I_{\text{DSS}}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = 650 \text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$			100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 25 \text{ V}$			$\pm 10$	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2	3	4	V
$R_{DS(\text{on})}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$		0.290	0.365	$\Omega$

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$	-	764	-	pF
$C_{oss}$	Output capacitance		-	35.5	-	pF
$C_{rss}$	Reverse transfer capacitance		-	1.2	-	pF
$C_{oss \text{ eq.}}^{(1)}$	Output equivalent capacitance	$V_{DS} = 0 \text{ to } 520 \text{ V}, V_{GS} = 0$	-	175.5	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 \text{ MHz}$ open drain	-	6	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 12 \text{ A}, V_{GS} = 10 \text{ V}$ (see <i>Figure 3</i> )	-	21.5	-	nC
$Q_{gs}$	Gate-source charge		-	3.2	-	nC
$Q_{gd}$	Gate-drain charge		-	11.3	-	nC

- $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 6.5 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 6 \text{ V}$ (see <i>Figure 7</i> )	-	11	-	ns
$t_r$	Rise time		-	7.5	-	ns
$t_{d(off)}$	Turn-on delay time		-	46	-	ns
$t_f$	Fall time		-	12.5	-	ns

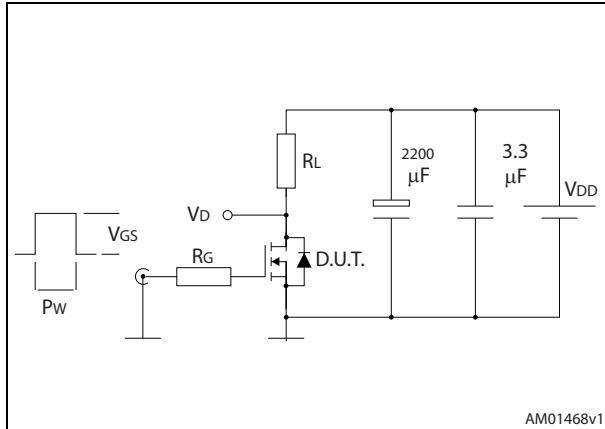
**Table 7. Source drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		8	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		32	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 8 \text{ A}, V_{GS} = 0$	-		1.6	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 12 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 60 \text{ V}$ (see <a href="#">Figure 4</a> )	-	331		ns
$Q_{rr}$	Reverse recovery charge		-	3.4		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	20.5		A
$t_{rr}$	Reverse recovery time	$V_{DD} = 60 \text{ V}$ $di/dt = 100 \text{ A}/\mu\text{s}, I_{SD} = 12 \text{ A}$ $T_j = 150^\circ\text{C}$ (see <a href="#">Figure 4</a> )	-	462		ns
$Q_{rr}$	Reverse recovery charge		-	4.6		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	20		A

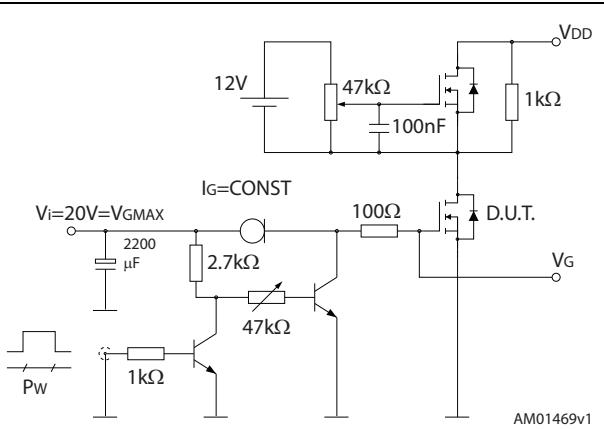
1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

### 3 Test circuits

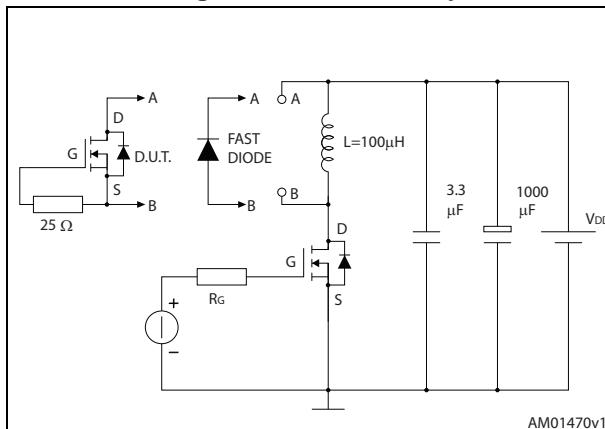
**Figure 2. Switching times test circuit for resistive load**



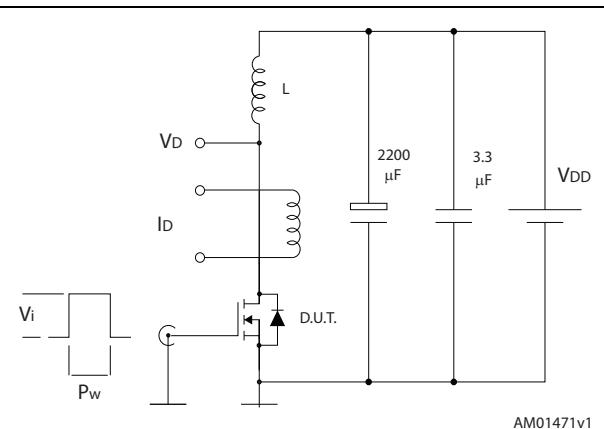
**Figure 3. Gate charge test circuit**



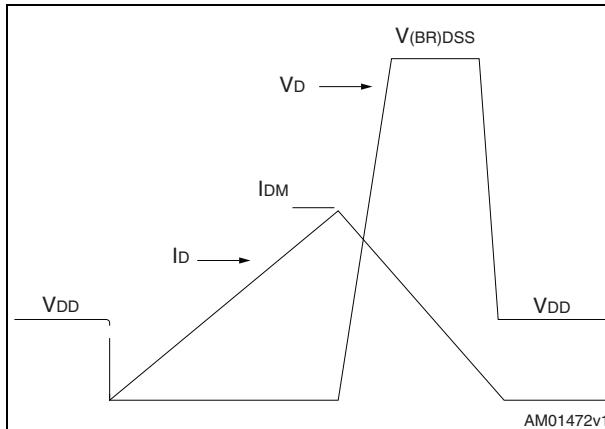
**Figure 4. Test circuit for inductive load switching and diode recovery times**



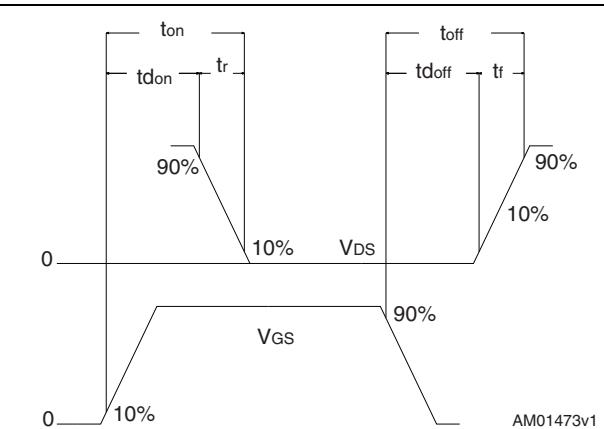
**Figure 5. Unclamped inductive load test circuit**



**Figure 6. Unclamped inductive waveform**

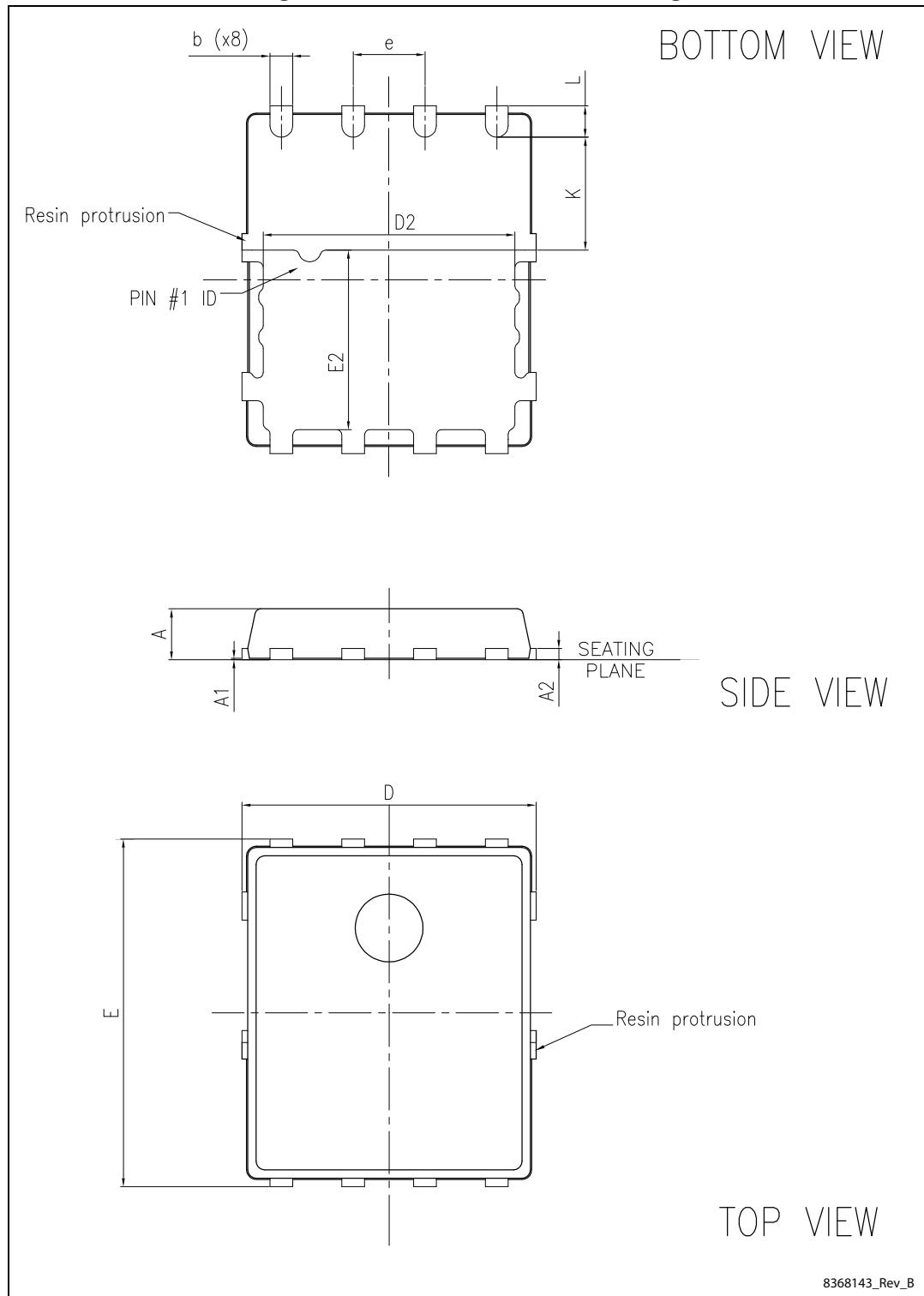


**Figure 7. Switching time waveform**



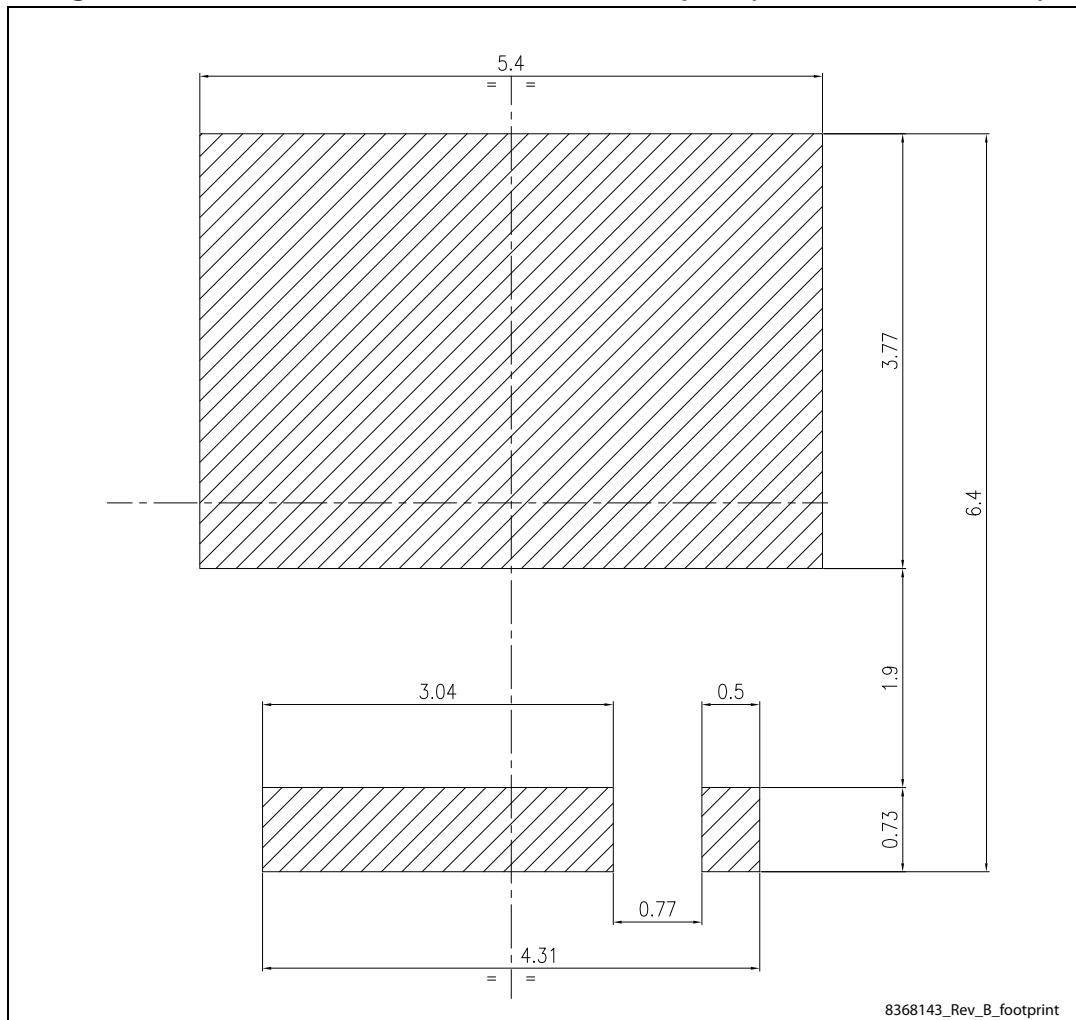
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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**Figure 8. PowerFLAT™ 5x6 HV drawing**

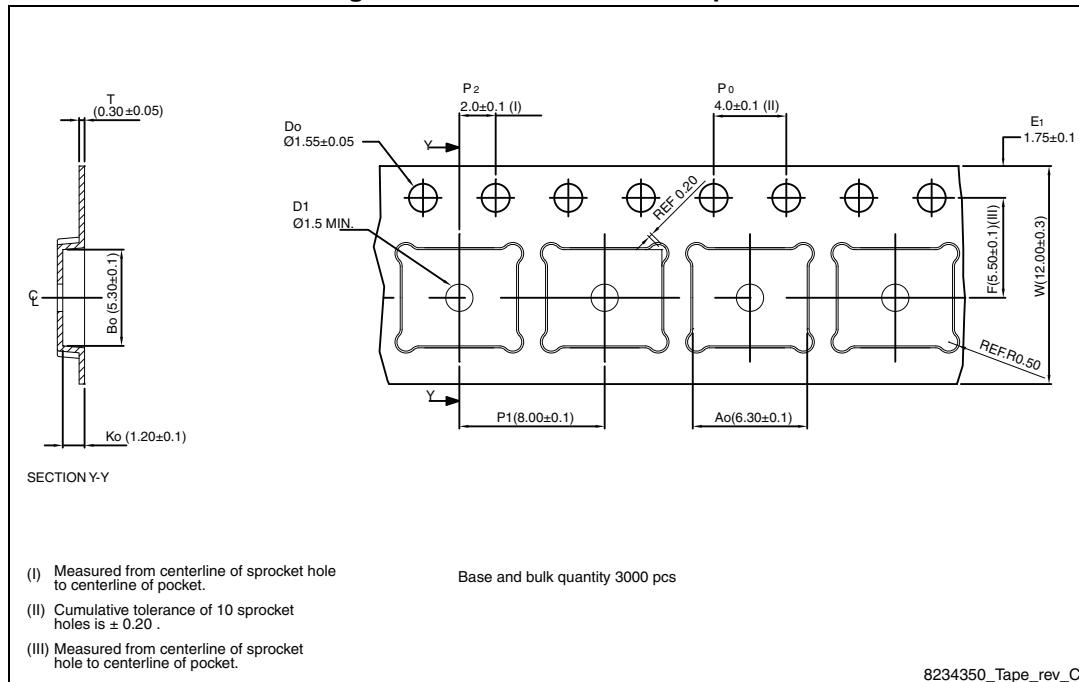
**Table 8. PowerFLAT™ 5x6 HV mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
E	5.95	6.15	6.35
D2	4.30	4.40	4.50
E2	3.10	3.20	3.30
e		1.27	
L	0.50	0.55	0.60
K	1.90	2.00	2.10

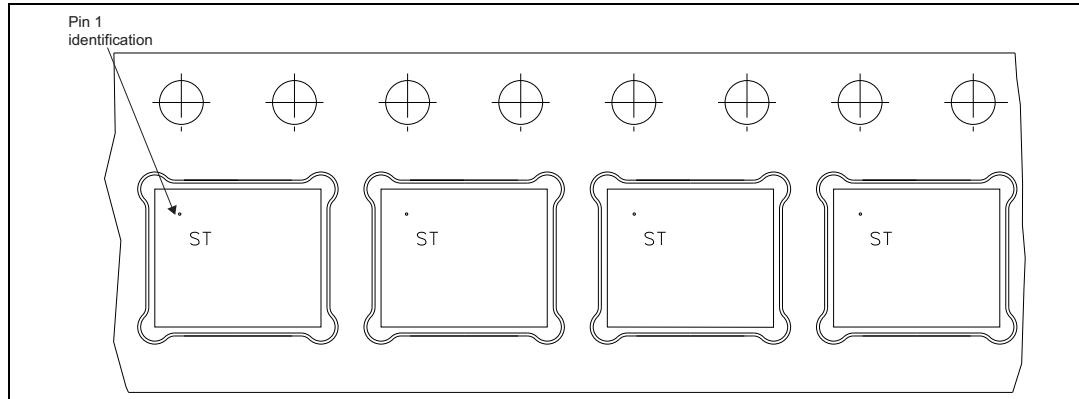
**Figure 9. PowerFLAT™ 5x6 HV recommended footprint (dimensions are in mm)**

## 5 Packaging mechanical data

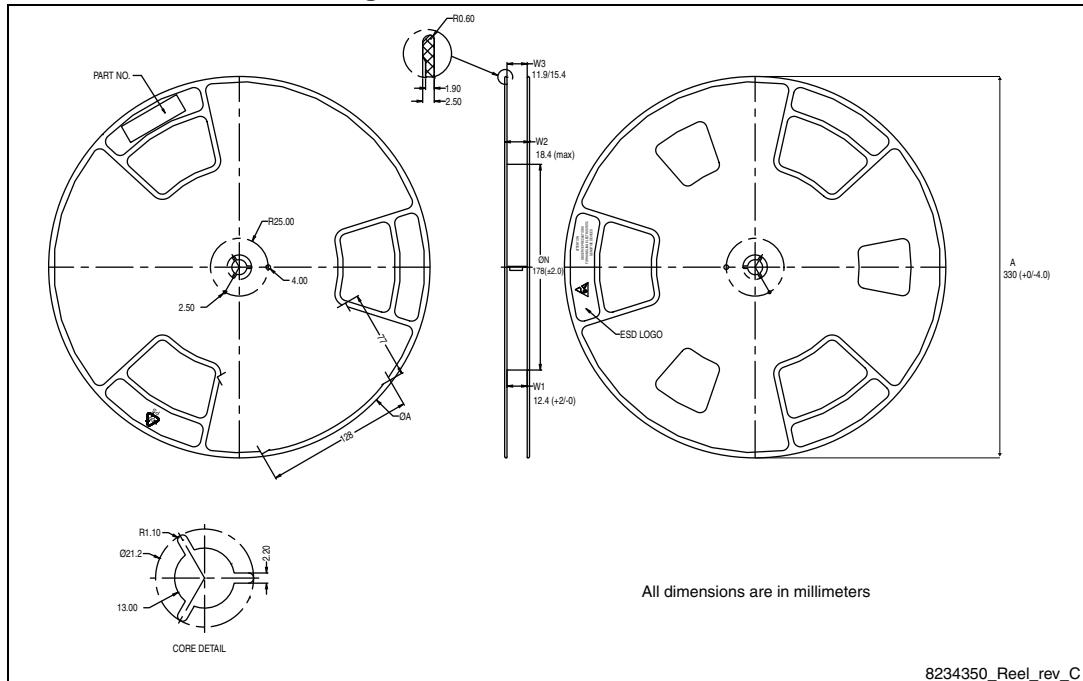
**Figure 10. PowerFLAT™ 5x6 tape<sup>(a)</sup>**



**Figure 11. PowerFLAT™ 5x6 package orientation in carrier tape**



a. All dimensions are in millimeters.

**Figure 12. PowerFLAT™ 5x6 reel**

## 6 Revision history

**Table 9. Document revision history**

Date	Revision	Changes
14-Mar-2014	1	First release.
25-Mar-2014	2	Updated title and features on cover page. Updated <a href="#">Table 4: On /off states</a> and <a href="#">Table 5: Dynamic</a> Inserted P <sub>TOT</sub> value in <a href="#">Table 2: Absolute maximum ratings</a> . Minor text changes.
02-Oct-2014	3	Updated values in <a href="#">Table 2: Absolute maximum ratings</a> , <a href="#">Table 4: On /off states</a> , <a href="#">Table 5: Dynamic</a> , <a href="#">Table 6: Switching times</a> and <a href="#">Table 7: Source drain diode</a> . Updated title, features and description in cover page. Minor text changes.

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